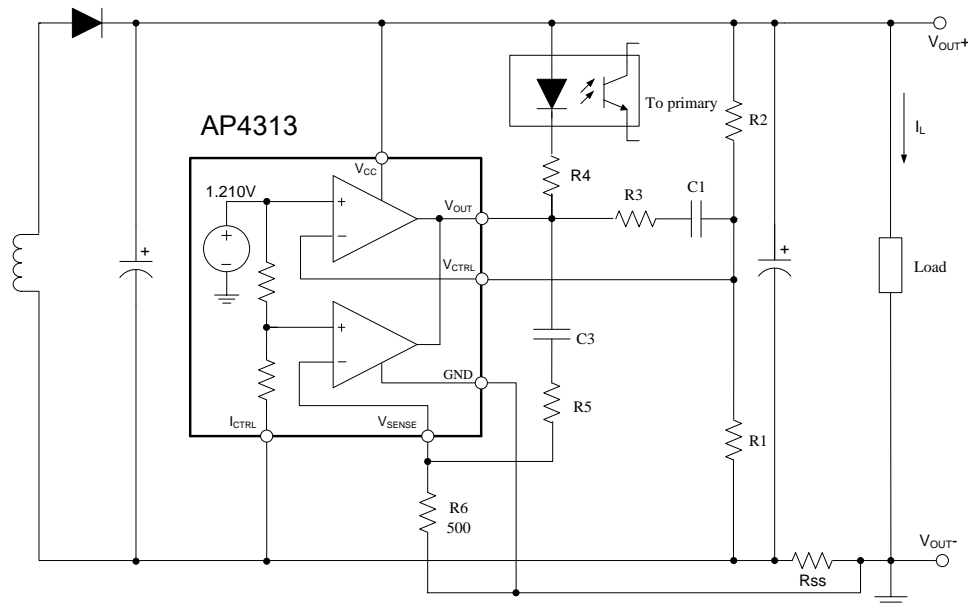


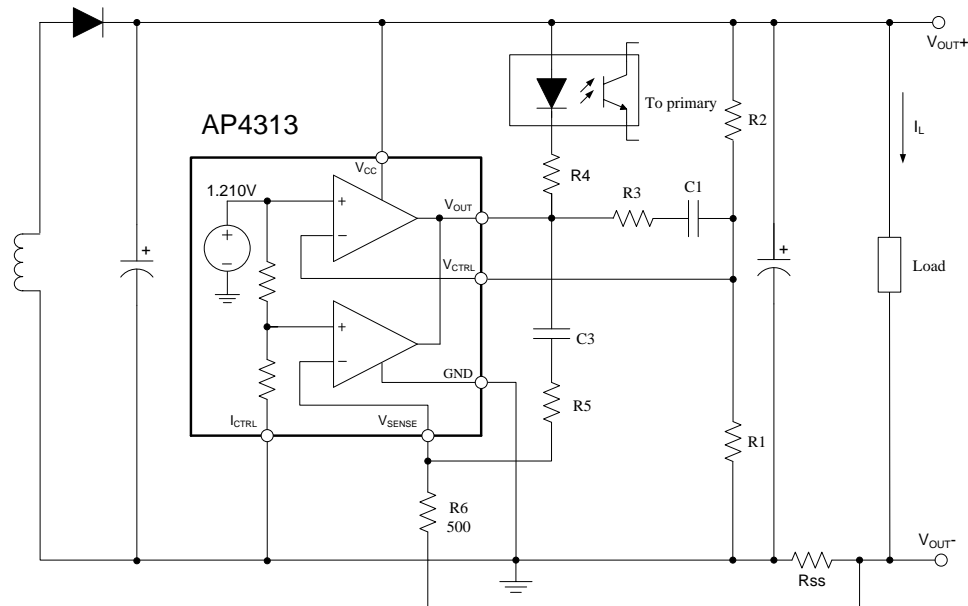
**Typical Applications Circuit (Cont.)**



$$V_{OUT} = [V_{REF} + (I_L \times R_{SS})] \times \frac{R1 + R2}{R1} - (I_L \times R_{SS}) \text{ (V)}$$

$$CurrentLimit = \frac{V_{SENSE}}{R_{SS}} \text{ (A)}$$

Typical Application 2



$$V_{OUT} = V_{REF} \times \frac{R1 + R2}{R1} - (I_L \times R_{SS}) \text{ (V)}$$

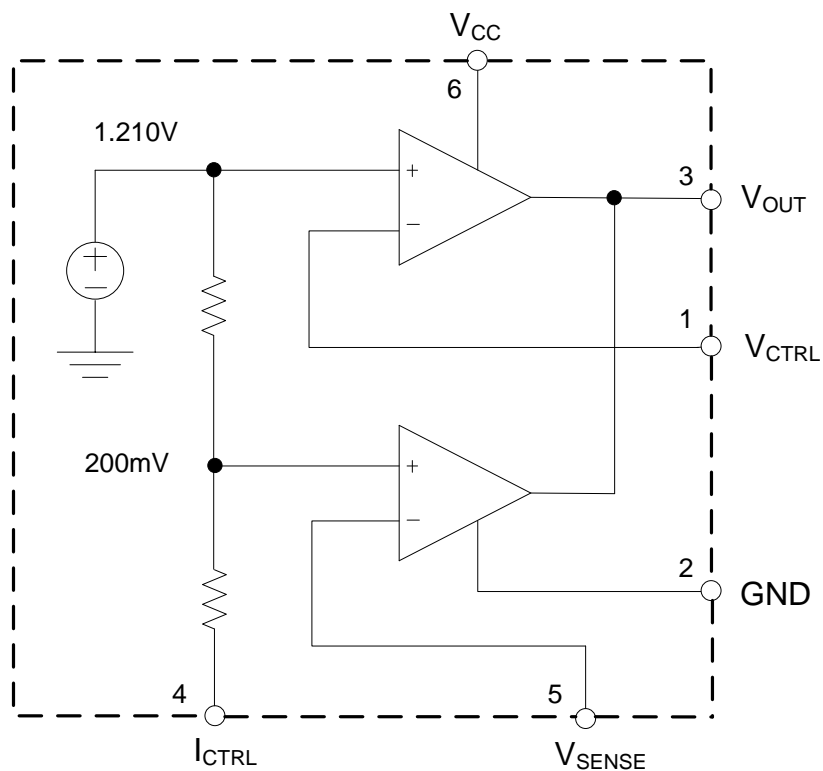
$$CurrentLimit = \frac{V_{SENSE} \times V_{REF}}{(V_{SENSE} + V_{REF}) \times R_{SS}} \text{ (A)}$$

Typical Application 3

## Pin Descriptions

Pin Number	Pin Name	Function
1	V <sub>CTRL</sub>	Input pin of the voltage control loop
2	GND	Ground
3	V <sub>OUT</sub>	Output pin. Sinking current only
4	I <sub>CTRL</sub>	Input pin of the current control loop
5	V <sub>SENSE</sub>	Input pin of the current control loop
6	V <sub>CC</sub>	Power supply

### Functional Block Diagram



## Absolute Maximum Ratings (Note 4)

Symbol	Parameter	Rating	Unit
$V_{CC}$	Power Supply Voltage	20	V
$V_{IN}$	Input Voltage	-0.3 to $V_{CC}$	V
$T_J$	Junction Temperature	+150	°C
$T_{STG}$	Storage Temperature	-65 to +150	°C
$T_{LEAD}$	Lead Temperature (Soldering, 5 sec)	+260	°C
$\theta_{JC}$	Package Thermal Resistance (Junction to Case)	92	°C/W

Note 4: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

## Recommended Operating Conditions

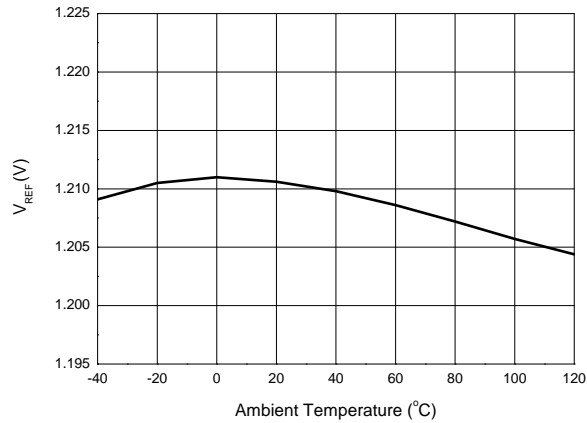
Symbol	Parameter	Min	Max	Unit
$V_{CC}$	Power Supply Voltage	2.5	18	V
$T_A$	Operating Temperature Range	-40	+105	°C

## Electrical Characteristics ( $V_{CC}=5V$ , $T_A=+25^{\circ}C$ , unless otherwise specified.)

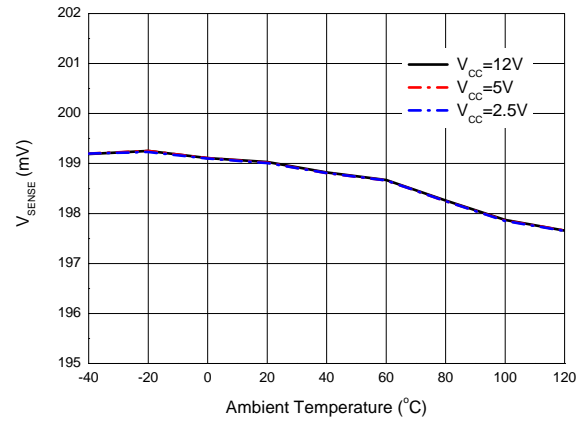
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>TOTAL CURRENT CONSUMPTION</b>						
$I_{CC}$	Total Supply Current Not Including the Output Sinking Current	–	–	0.6	1.2	mA
<b>VOLTAGE CONTROL LOOP</b>						
$G_{mv}$	Transconduction Gain ( $V_{CTRL}$ ). Sink Current Only	–	1	3.5	–	mA/mV
$V_{REF}$	Voltage Control Loop Reference	–	1.198	1.21	1.222	V
$I_{IBV}$	Input Bias Current ( $V_{CTRL}$ )	–	–	50	–	nA
<b>CURRENT CONTROL LOOP</b>						
$G_{mi}$	Transconduction Gain ( $I_{CTRL}$ )	–	1.5	7	–	mA/mV
$V_{SENSE}$	Current Control Loop Reference	$I_{OUT}=2.5mA$	196	200	204	mV
$I_{IBI}$	Current Out of Pin $I_{CTRL}$ at -200mV	–	–	25	–	μA
<b>OUTPUT STAGE</b>						
$V_{OL}$	Low Output Voltage at 10mA Sinking Current	–	–	200	–	mV
$I_{OS}$	Output Short Circuit Current. Output to $V_{CC}$ . Sink Current Only	–	–	27	50	mA

## Performance Characteristics

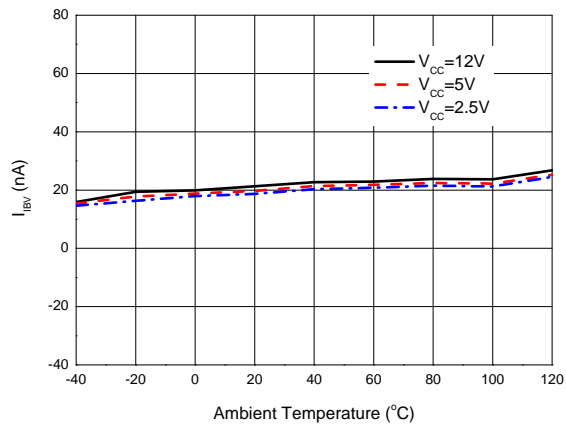
**V<sub>REF</sub> vs. Ambient Temperature**



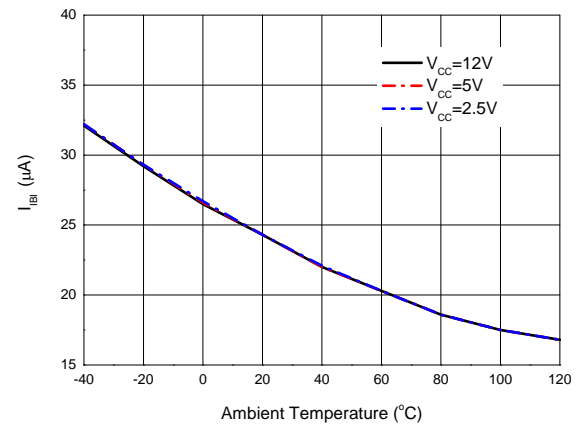
**V<sub>SENSE</sub> vs. Ambient Temperature**



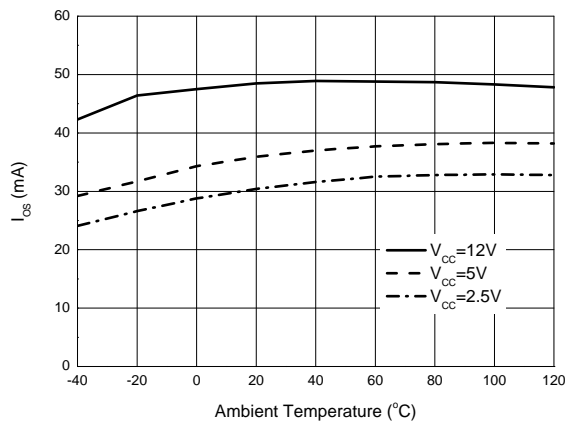
**V<sub>CTRL</sub> Pin Input Bias Current vs. Ambient Temperature**



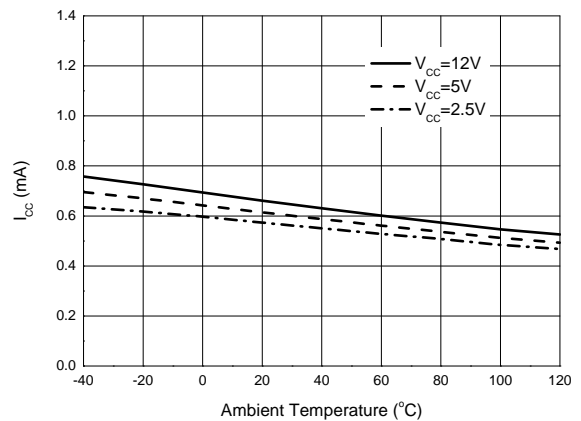
**I<sub>CTRL</sub> Pin Input Bias Current vs. Ambient Temperature**



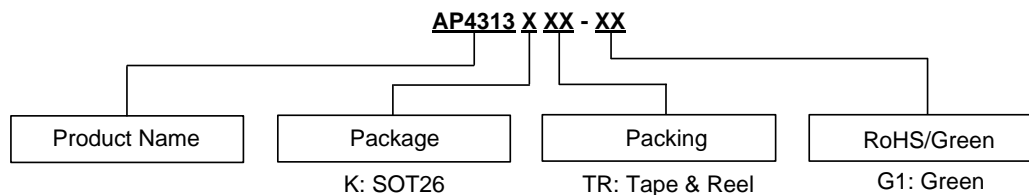
**Output Short Circuit Current vs. Ambient Temperature**



**Supply Current vs. Ambient Temperature**



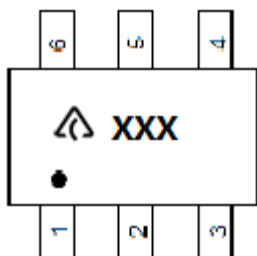
## Ordering Information




Package	Temperature Range	Part Number	Marking ID	Packing
SOT26	-40 to +105°C	AP4313KTR-G1	G6G	3000/Tape & Reel

## Marking Information

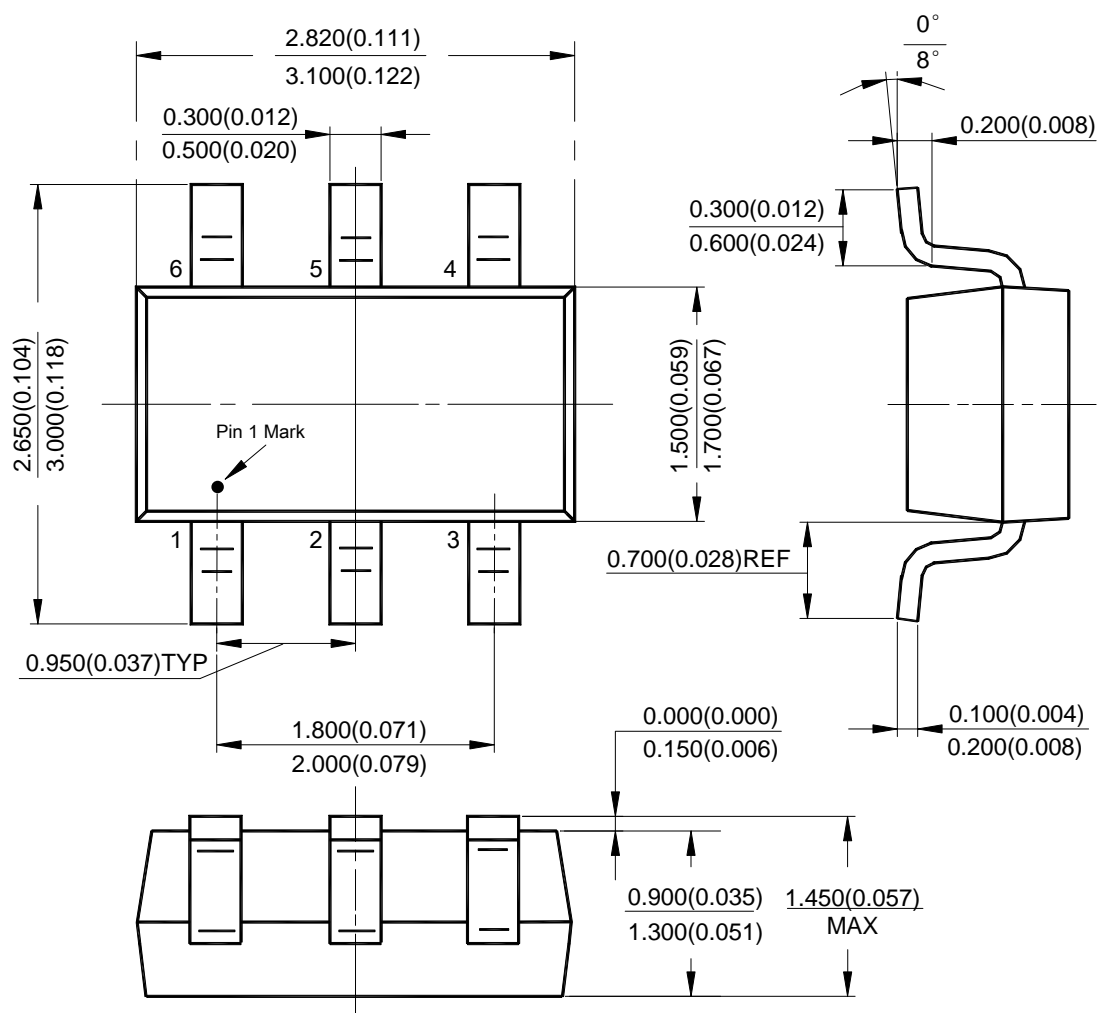
(Top View)



 : Logo  
 XXX: Marking ID

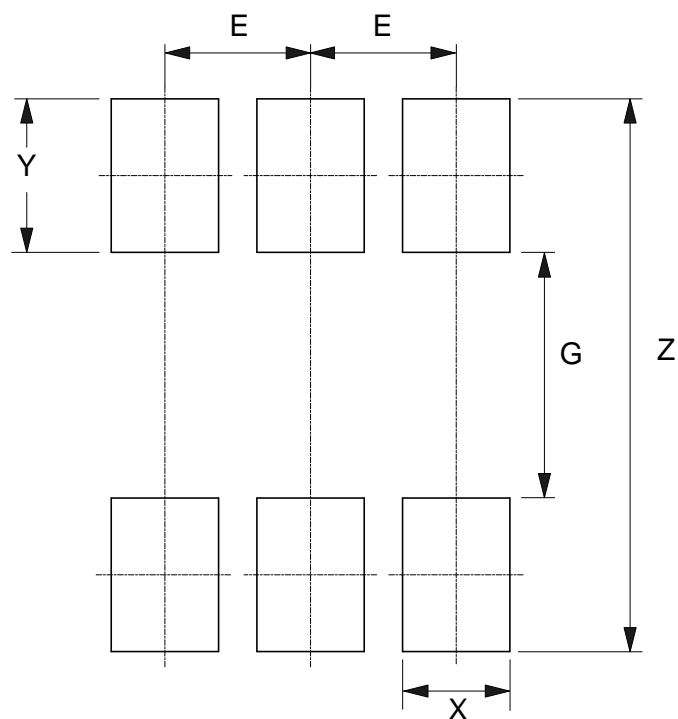
### Package Outline Dimensions (All dimensions in mm(inch).)

**(1) Package Type: SOT26**



## Suggested Pad Layout

(1) Package Type: SOT26



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	E (mm)/(inch)
Value	3.600/0.142	1.600/0.063	0.700/0.028	1.000/0.039	0.950/0.037

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